Product data sheet

1. General description

High-speed switching diode, encapsulated in a leadless ultra small DFN1006BD-2 (SOD882BD) Surface-Mounted Device (SMD) plastic package with side-wettable flanks.

2. Features and benefits

- High switching speed: t_{rr} ≤ 4 ns
- Low leakage current
- Repetitive peak reverse voltage V_{RRM} ≤ 100 V
- · Suitable for Automatic Optical Inspection (AOI) of solder joint
- Low capacitance
- Reverse voltage V_R ≤ 100 V
- · Ultra small and leadless SMD plastic package
- AEC-Q101 qualified

3. Applications

- · High-speed switching
- · General-purpose switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _F	forward current	T _j = 25 °C	[1]	-	-	215	mA
I _R	reverse current	V _R = 80 V; T _j = 25 °C		-	-	0.5	μΑ
V_R	reverse voltage	T _j = 25 °C		-	-	100	V
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.



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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		K - ← A
2	А	anode		aaa-028035
			Transparent top view	
			DFN1006BD-2 (SOD882BD)	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BAS16LS		Leadless ultra small plastic package with side-wettable flanks (SWF); 2 terminals; 0.65 mm pitch; 1 mm x 0.6 mm x 0.47 mm body	SOD882BD			

7. Marking

Table 4. Marking codes

Type number	Marking code
BAS16LS	M8

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	T _j = 25 °C		-	100	V
V_R	reverse voltage			-	100	V
I _F	forward current		[1]	-	215	mA
I _{FSM}	non-repetitive peak	t_p = 1 µs; square wave; $T_{j(init)}$ = 25 °C		-	4	Α
	forward current	t_p = 1 ms; square wave; $T_{j(init)}$ = 25 °C		-	1	А
		t _p = 1 s; square wave; T _{j(init)} = 25 °C		-	0.5	А
I _{FRM}	repetitive peak forward current	$t_p \le 0.5 \text{ ms}; \delta \le 0.25$		-	500	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	345	mW
			[2]	-	645	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.

^[2] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated mounting pad for cathode 1cm².

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui()-a)	thermal resistance from	in free air	[1]	-	-	360	K/W
	junction to ambient		[2]	-	-	195	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 µm single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), 70 μm single-sided copper, tin-plated mounting pad for cathode 1cm².

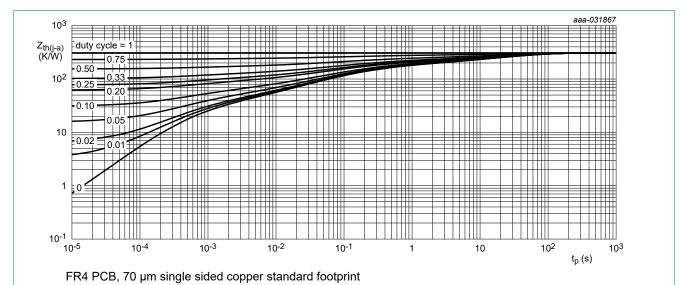


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

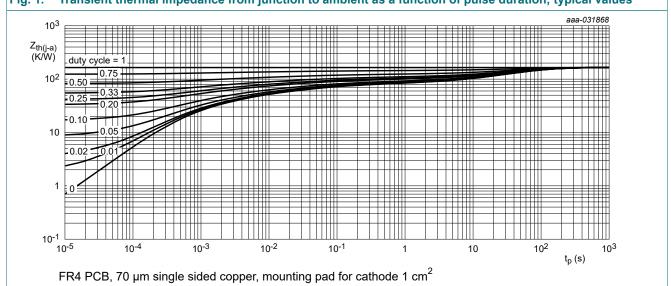


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

High-speed switching diode

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I_F = 1 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-	715	mV
		I_F = 10 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-	855	mV
		I_F = 50 mA; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-	1	V
		I_F = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$; T_{amb} = 25 °C	-	-	1.25	V
I _R	reverse current	V _R = 25 V; T _j = 25 °C	-	-	30	nA
		V _R = 80 V; T _j = 25 °C	-	-	0.5	μΑ
		V _R = 25 V; T _j = 150 °C	-	-	30	μΑ
		V _R = 80 V; T _j = 150 °C	-	-	50	μΑ
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; T _{amb} = 25 °C	-	-	1.5	pF
t _{rr}	reverse recovery time	I_F = 10 mA; I_R = 10 mA; R_L = 100 Ω; $I_{R(meas)}$ = 1 mA; T_{amb} = 25 °C	-	-	4	ns
V_{FRM}	peak forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{amb} = 25 \text{ °C}$	-	-	1.75	V

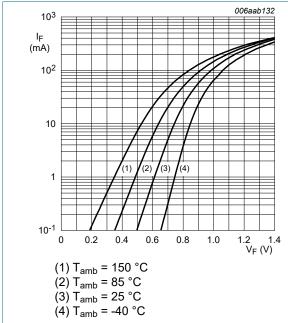
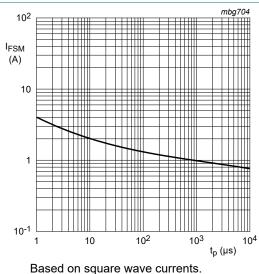


Fig. 3. Forward current as a function of forward voltage; typical values



Based on square wave currents. $T_{j(init)} = 25 \, ^{\circ}C$

Fig. 4. Non-repetitive peak forward current as a function of pulse duration; typical values

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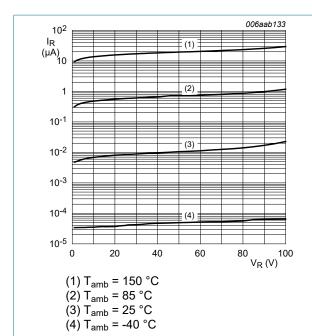


Fig. 5. Reverse current as a function of reverse voltage; typical values

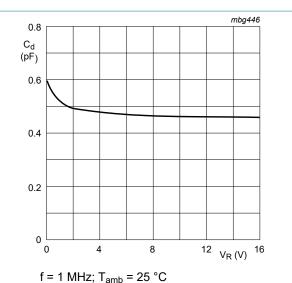
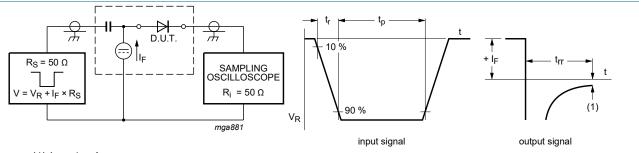


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

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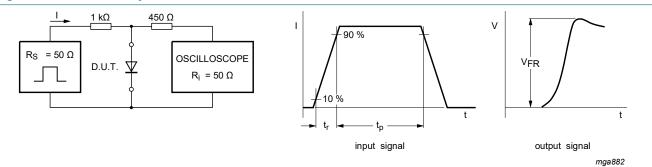
11. Test information



(1) $I_R = 1 \text{ mA}$

Input signal: reverse pulse rise time t_r = 0.6 ns; reverse voltage pulse duration t_p = 100 ns; duty cycle δ = 0.05 Oscilloscope: rise time t_r = 0.35 ns

Fig. 7. Reverse recovery time test circuit and waveforms



Input signal: forward pulse rise time t_r = 20 ns; forward current pulse duration $t_p \ge 100$ ns; duty cycle $\delta \le 0.005$

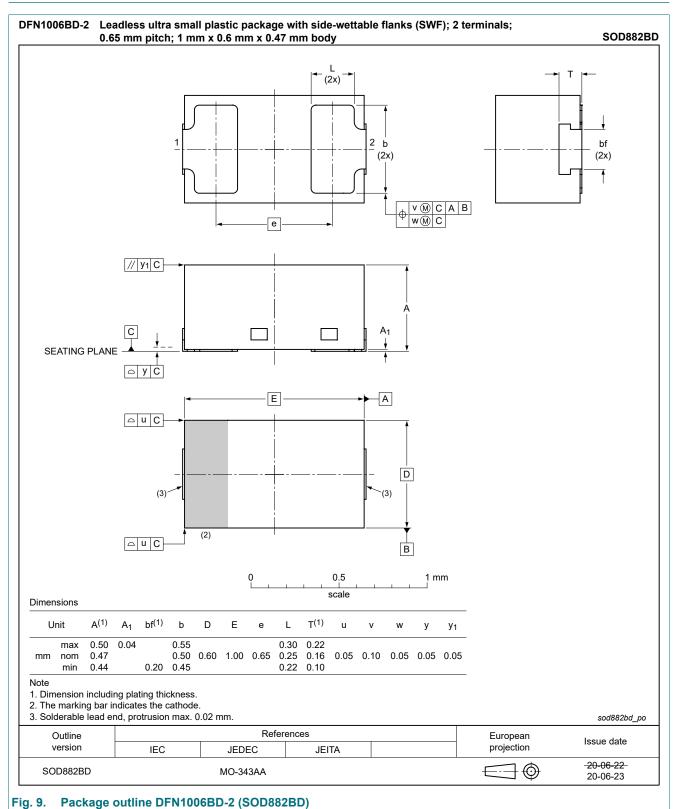
Fig. 8. Forward recovery voltage test circuit and waveforms

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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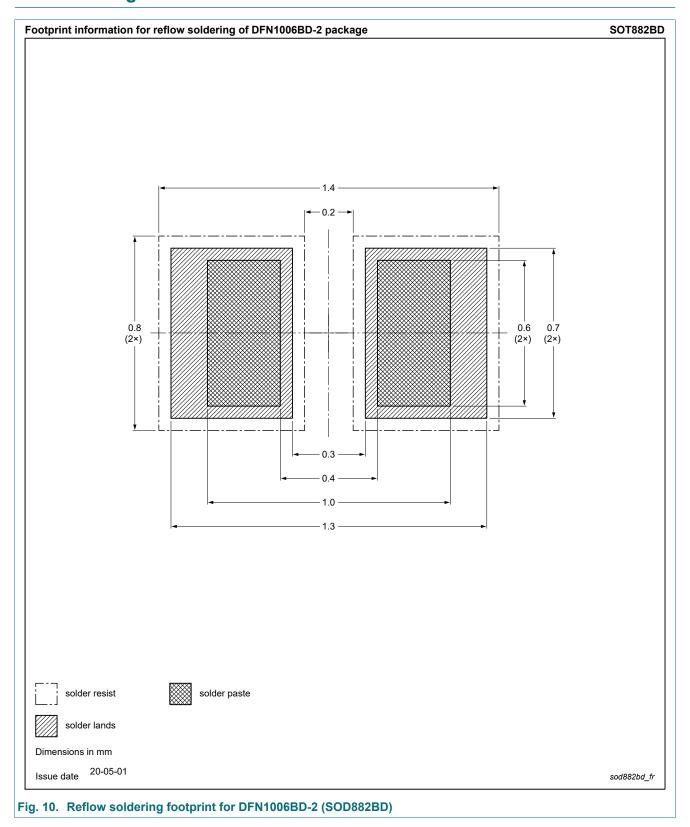
12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAS16LS v.1	20200907	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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